

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L14	32	ground near3 (metal or metallization) with ((copper or Cu) and (nickel or Ni) and (gold or Au))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/27 10:46
L21	753	(copper or Cu) with (nickel or Ni) with (gold or Au) and (LED or light near3 diode) and (cup or cavity or recess) with (base or substrate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/27 10:53
L22	247	21 and @pd< "20031225"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/27 10:53
L24	901	(257/79-82,84,91,95,98-100,E33.00,E33.055-E33.06,E33.066,E33.068). ccls. and @pd> "20071215"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/27 11:45
L32	20	24 and (LED or light near3 diode) same (cup or recess or cavity) and resin and light near receiv \$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/27 11:49
L33	23	((TOMOHARU) near2 (HARIO)).INV.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/08/27 11:50
L34	4	ROHM.as. and (light near (emit\$4 and receiv\$3) and IC (chip or die) and resin).clm.	US-PGPUB; USPAT; USOCR	ADJ	ON	2008/08/27 11:55

8/ 27/ 2008 11:58:00 AM

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